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JAN 24 2006From: Jacqueline J. Garner
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Phone: 214-532-9348**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: DeLoach et al.

Art Unit: 2822

Serial No.: 10/689,177

Examiner: Guerrero, M.

Filing Date: 10/20/2003

Docket No.: TI-35986

Customer No.: 23494

Conf. No.: 2711

Title: AN IN SITU HARDMASK PULLBACK USING AN IN SITU PLASMA RESIST
TRIM PROCESS**CERTIFICATION OF FACSIMILE TRANSMISSION**I hereby certify that the following papers are being transmitted by facsimile to the
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NAME OF INVENTOR(S): De Loach		RECEIPT DATE & SERIAL NO.: Serial No.: 10/689,177
TITLE OF INVENTION: An In-situ Hardmask Pullback . . .		Filing Date: 10/20/2003
TI FILE NO.: TI-35986	DEPOSIT ACCT. NO.: 20-0668	Conf. No.: 2711
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